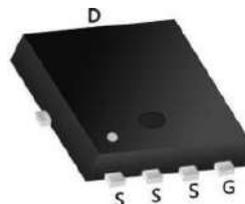


## N-Ch 60V Fast Switching MOSFETs

### Features:

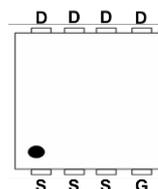
- Advanced Trench MOS Technology
- Low Gate Charge
- Low  $R_{DS(ON)}$
- 100% EAS Guaranteed
- Green Device Available



PRPAK5X6 Pin Configuration

### Application:

- Motor Control.
- DC/DC Converter.
- Synchronous rectifier applications.



### Product Summary

| BVDSS | RDS(ON) | ID  |
|-------|---------|-----|
| 60V   | 5.2mΩ   | 80A |

### Absolute Maximum Ratings

| Symbol                 | Parameter                                  | Rating     | Units |
|------------------------|--|------------|-------|
| $V_{DS}$               | Drain-Source Voltage                       | 60         | V     |
| $V_{GS}$               | Gate-Source Voltage                        | ±20        | V     |
| $I_D@T_C=25^{\circ}C$  | Continuous Drain Current <sup>1,6</sup>    | 80         | A     |
| $I_D@T_C=100^{\circ}C$ |  | 51         | A     |
| $I_{DM}$               | Pulsed Drain Current <sup>2</sup>          | 300        | A     |
| EAS                    | Single Pulse Avalanche Energy <sup>3</sup> | 92.5       | mJ    |
| $I_{AS}$               | Avalanche Current                          | 43         | A     |
| $P_D@T_C=25^{\circ}C$  | Total Power Dissipation <sup>4</sup>       | 54.3       | W     |
| $T_{STG}$              | Storage Temperature Range                  | -55 to 150 | °C    |
| $T_J$                  | Operating Junction Temperature Range       | -55 to 150 | °C    |

### Thermal Data

| Symbol          | Parameter   | Typ. | Max. | Unit |
|-----------------|---|------|------|------|
| $R_{\theta JA}$ | Thermal Resistance Junction-ambient <sup>1</sup> ( $t \leq 10S$ ) | ---  | 25   | °C/W |
|                 | Thermal Resistance Junction-ambient <sup>1</sup> (Steady State)   | ---  | 55   | °C/W |
| $R_{\theta JC}$ | Thermal Resistance Junction-case <sup>1</sup>                     | ---  | 2.3  | °C/W |

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**

| Symbol       | Parameter                                      | Conditions                                       | Min. | Typ. | Max.      | Unit       |
|--------------|--|--|------|------|-----------|------------|
| $BV_{DSS}$   | Drain-Source Breakdown Voltage                 | $V_{GS}=0V, I_D=250\mu A$                        | 60   | ---  | ---       | V          |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance <sup>2</sup> | $V_{GS}=10V, I_D=20A$                            | ---  | 4.4  | 5.2       | m $\Omega$ |
|              |  | $V_{GS}=4.5V, I_D=10A$                           | ---  | 6.4  | 7.8       | m $\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage                         | $V_{GS}=V_{DS}, I_D=250\mu A$                    | 1.2  | 1.65 | 2.3       | V          |
| $I_{DSS}$    | Drain-Source Leakage Current                   | $V_{DS}=48V, V_{GS}=0V, T_J=25^\circ\text{C}$    | ---  | ---  | 1         | $\mu A$    |
|              |  | $V_{DS}=48V, V_{GS}=0V, T_J=55^\circ\text{C}$    | ---  | ---  | 5         |            |
| $I_{GSS}$    | Gate-Source Leakage Current                    | $V_{GS}=\pm 20V, V_{DS}=0V$                      | ---  | ---  | $\pm 100$ | nA         |
| $R_g$        | Gate Resistance                                | $V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$            | ---  | 1.3  | ---       | $\Omega$   |
| $Q_g$        | Total Gate Charge (10V)                        | $V_{DS}=30V, V_{GS}=10V, I_D=20A$                | ---  | 33.4 | ---       | nC         |
| $Q_g$        | Total Gate Charge (4.5V)                       |  | ---  | 17.8 | ---       |            |
| $Q_{gs}$     | Gate-Source Charge                             |  | ---  | 5.8  | ---       |            |
| $Q_{gd}$     | Gate-Drain Charge                              |  | ---  | 7.9  | ---       |            |
| $T_{d(on)}$  | Turn-On Delay Time                             | $V_{DD}=30V, V_{GS}=10V, R_G=3.3\Omega, I_D=20A$ | ---  | 7.5  | ---       | ns         |
| $T_r$        | Rise Time                                      |  | ---  | 6    | ---       |            |
| $T_{d(off)}$ | Turn-Off Delay Time                            |  | ---  | 29   | ---       |            |
| $T_f$        | Fall Time                                      |  | ---  | 7.5  | ---       |            |
| $C_{iss}$    | Input Capacitance                              | $V_{DS}=30V, V_{GS}=0V, f=1\text{MHz}$           | ---  | 1625 | ---       | pF         |
| $C_{oss}$    | Output Capacitance                             |  | ---  | 438  | ---       |            |
| $C_{riss}$   | Reverse Transfer Capacitance                   |  | ---  | 25   | ---       |            |

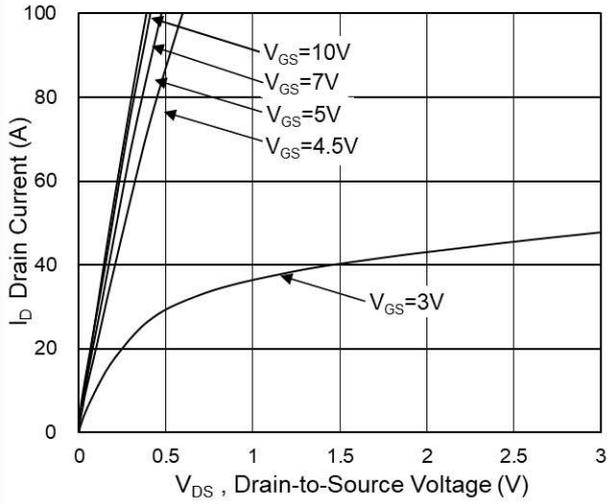
**Diode Characteristics**

| Symbol   | Parameter                                  | Conditions  | Min. | Typ. | Max. | Unit |
|----------|--|---|------|------|------|------|
| $I_S$    | Continuous Source Current <sup>1,5,6</sup> | $V_G=V_D=0V$ , Force Current                      | ---  | ---  | 60   | A    |
| $V_{SD}$ | Diode Forward Voltage <sup>2</sup>         | $V_{GS}=0V, I_S=1A, T_J=25^\circ\text{C}$         | ---  | ---  | 1.2  | V    |
| $t_{rr}$ | Reverse Recovery Time                      | $I_F=20A, dI/dt=400A/\mu s, T_J=25^\circ\text{C}$ | ---  | 23   | ---  | nS   |
| $Q_{rr}$ | Reverse Recovery Charge                    | $T_J=25^\circ\text{C}$                            | ---  | 60   | ---  | nC   |

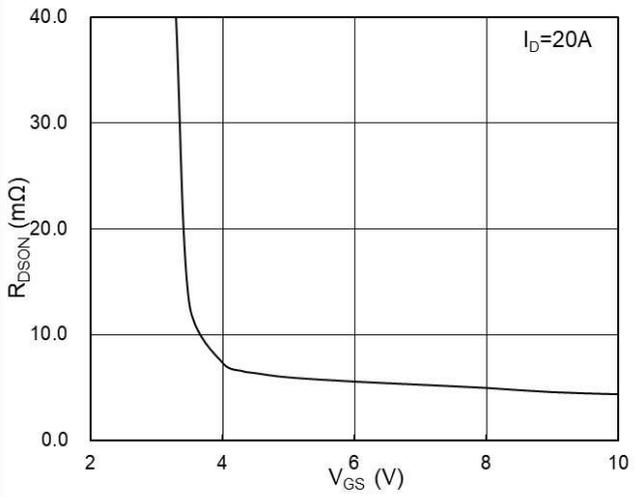
Note :

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
2. Single pulse width limited by junction temperature  $T_{J(MAX)}=150^\circ\text{C}$ .
- 3.The EAS data shows Max. rating . The test condition is  $V_{DD}=25V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=43A$
- 4.The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
- 5.The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications , should be limited by total power dissipation.
- 6.The maximum current rating is package limited.

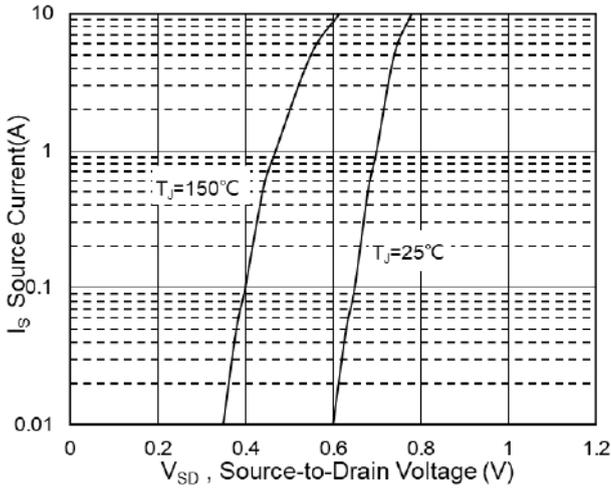
**Typical Characteristics**



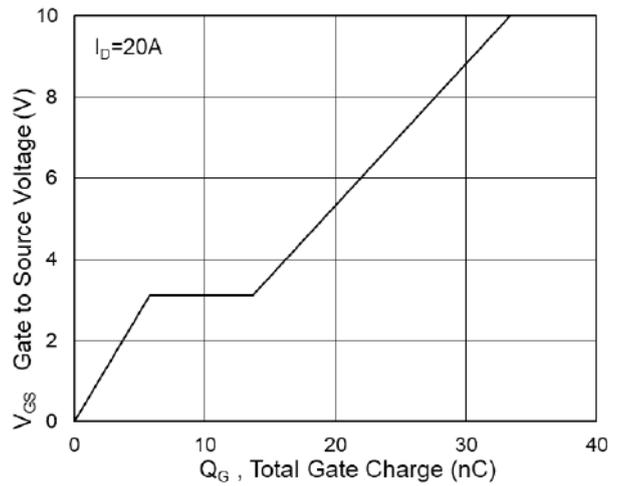
**Fig.1 Typical Output Characteristics**



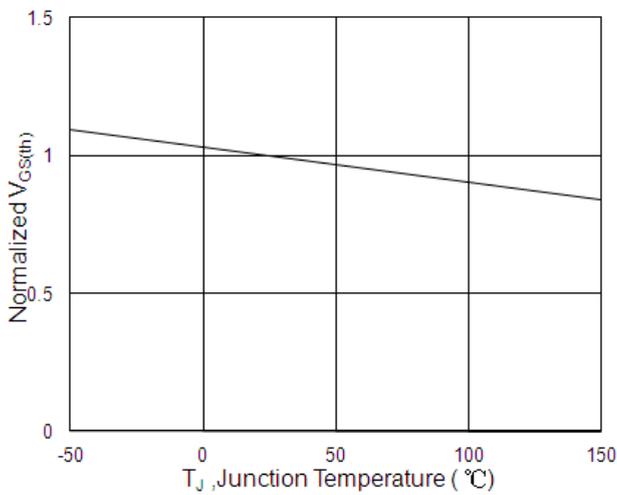
**Fig.2 On-Resistance vs G-S Voltage**



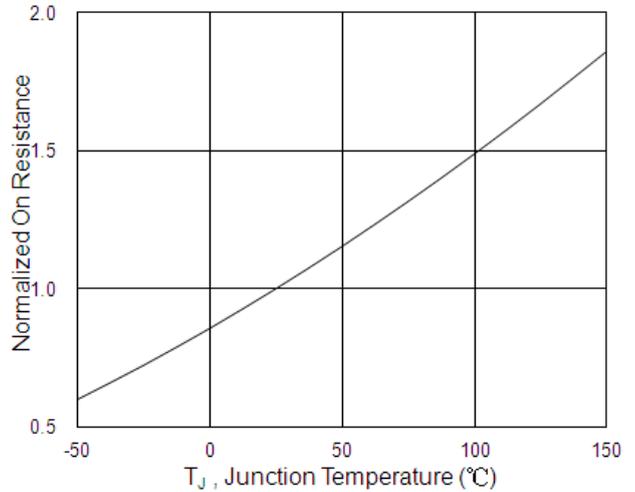
**Fig.3 Source Drain Forward Characteristics**



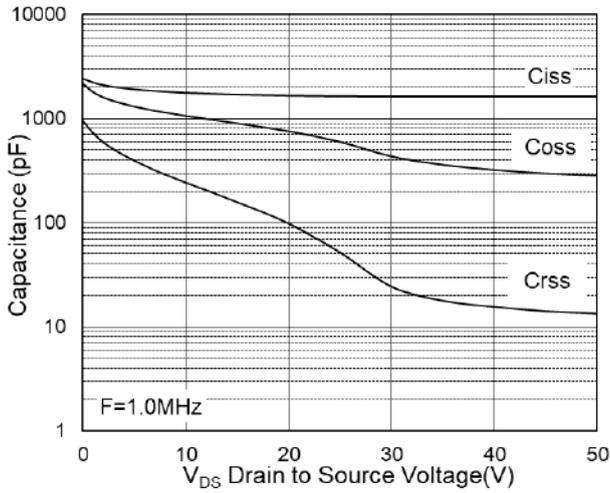
**Fig.4 Gate-Charge Characteristics**



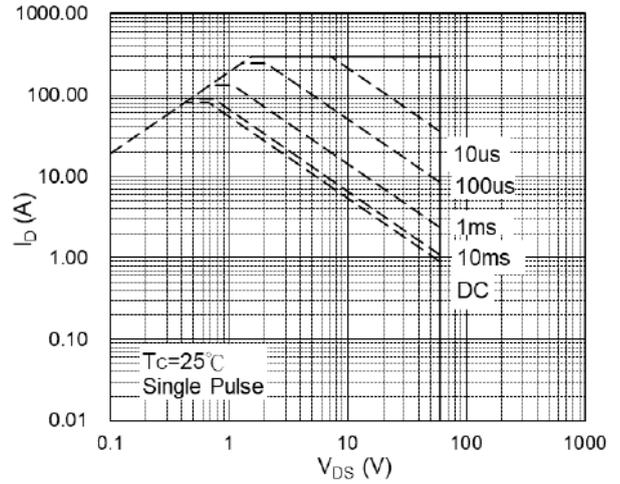
**Fig.5 Normalized  $V_{GS(th)}$  vs  $T_J$**



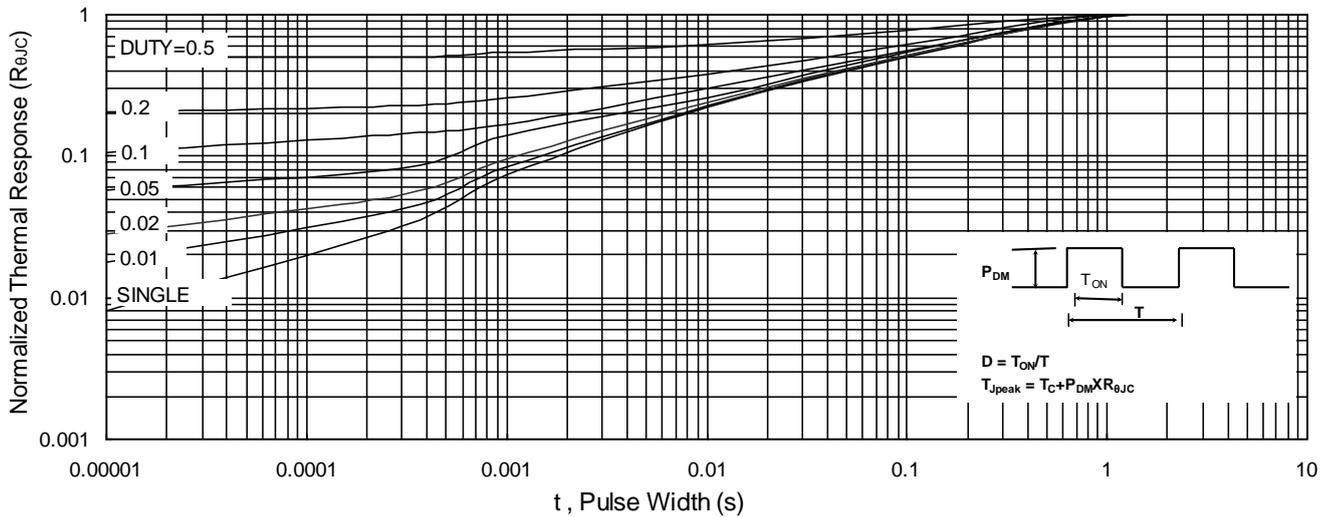
**Fig.6 Normalized  $R_{DS(on)}$  vs  $T_J$**



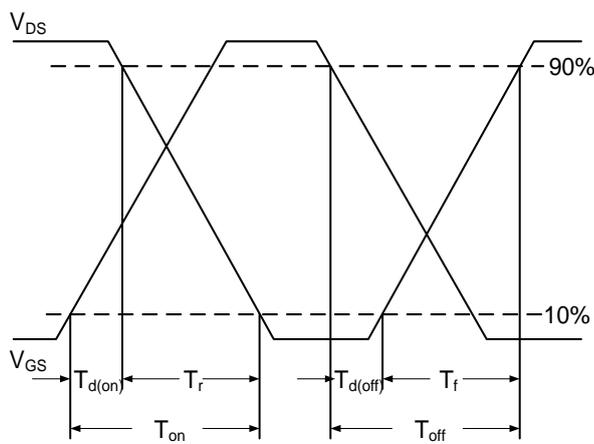
**Fig.7 Capacitance**



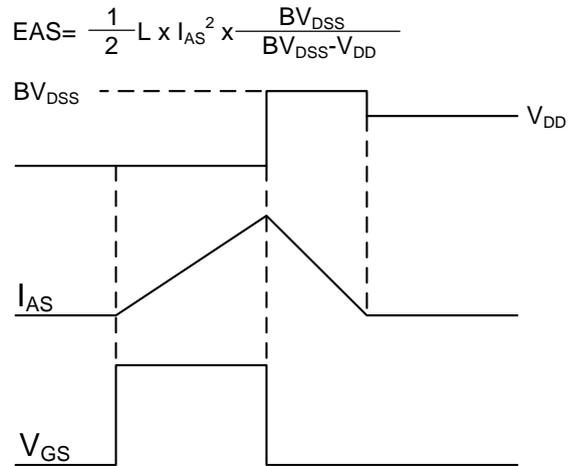
**Fig.8 Safe Operating Area**



**Fig.9 Normalized Maximum Transient Thermal Impedance**



**Fig.10 Switching Time Waveform**



**Fig.11 Unclamped Inductive Switching Waveform**